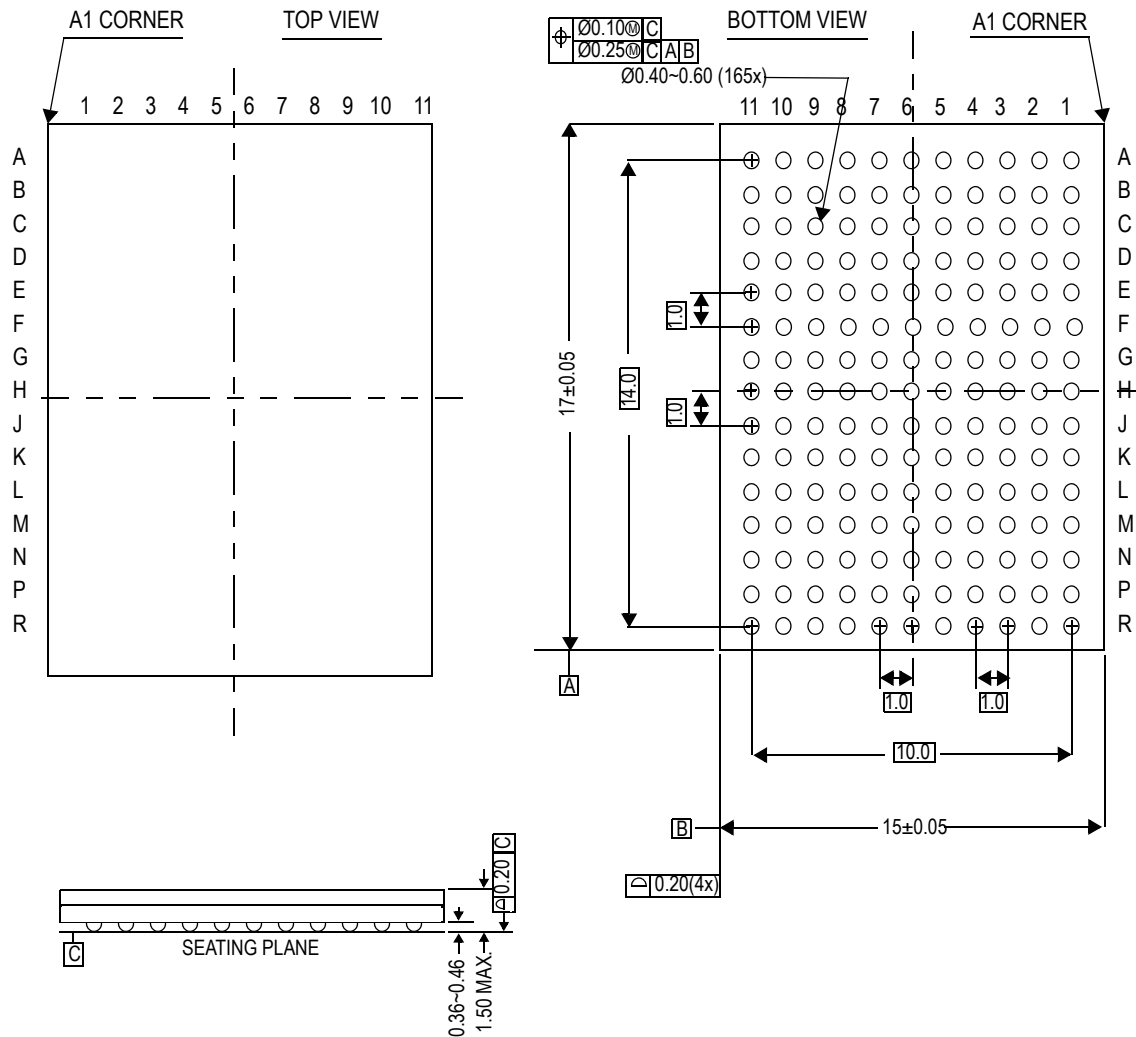


## 165-Bump BGA (15 mm x 17 mm) DummyDie™ Daisy Chain Package

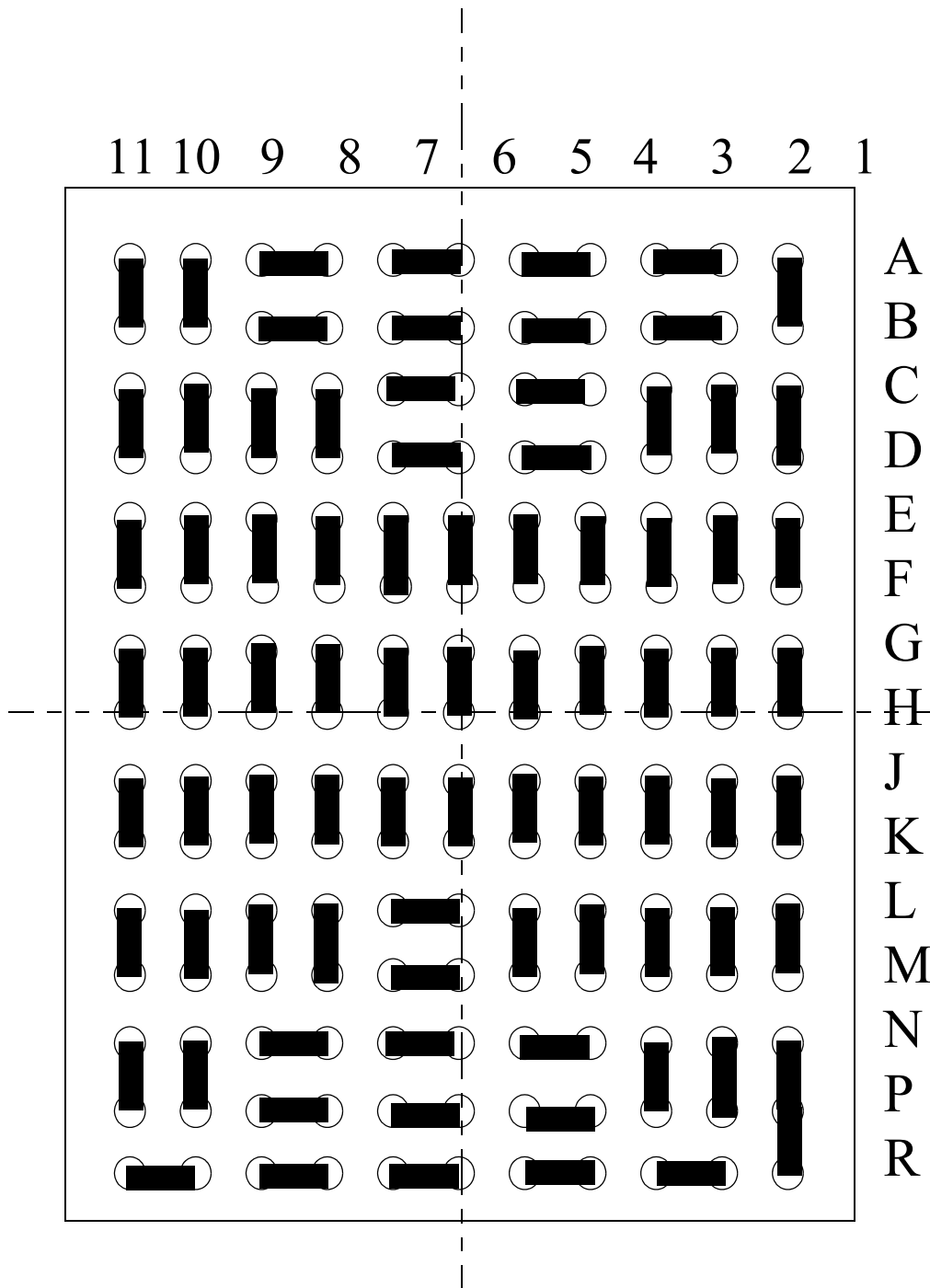
### Description

This mechanical daisy chain test vehicle is designed to represent the 165-Bump BGA package. It is used for second level interconnect assembly test and continuity verification. The DummyDie™ incorporates a 10 mm x 15 mm die, which is not electrically connected.

### Package Dimensions—165-Bump FPBGA (Package E)



165-Bump FPBGA Interconnection Diagram (Package E)



**Ordering Information**

**165-Bump BGA (15 mm x 17 mm)  
Daisy Chain Package**

**GSDC165ADE**



**165-Bump BGA (15 mm x 17 mm)  
Daisy Chain Package  
RoHS-compliant Option**

**GSDC165ADGE**

